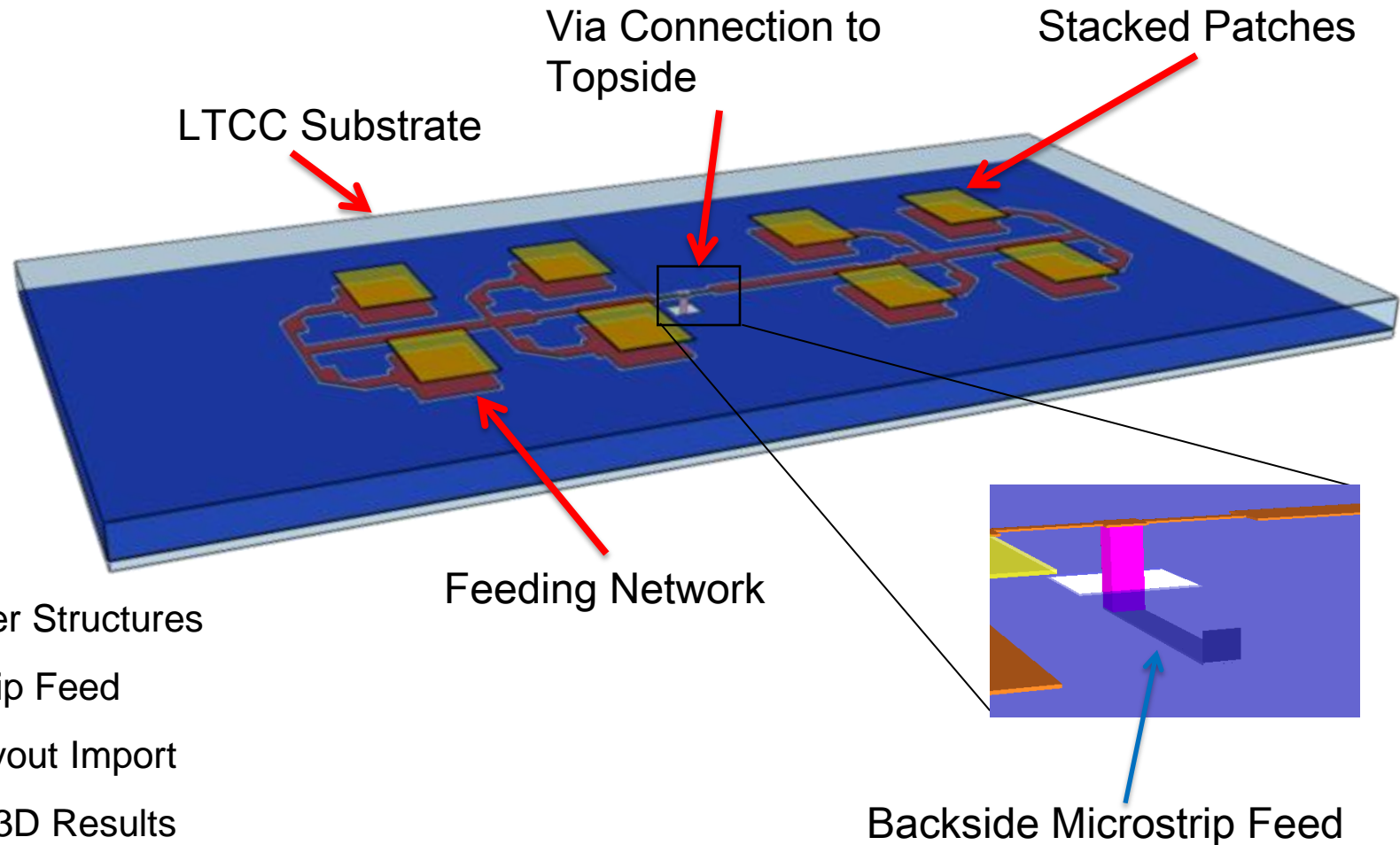


# EMPIRE XPU Tutorial

## Array Antenna with Feeding Network




# Overview: Topics

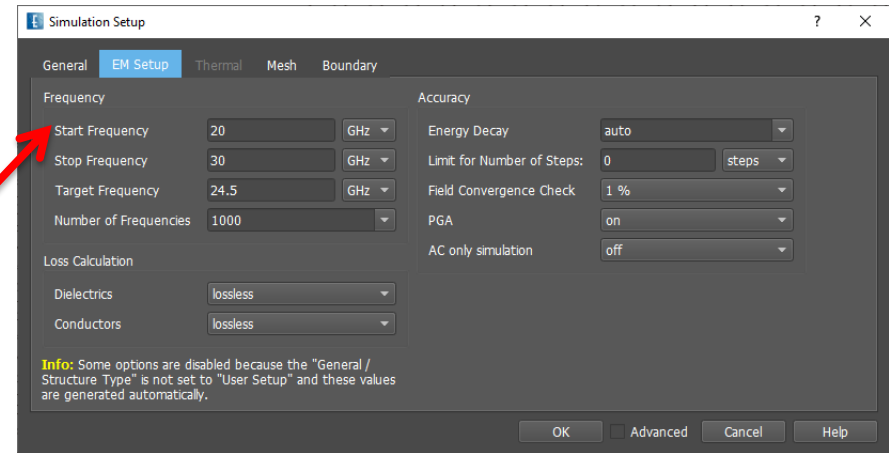


- Multilayer Structures
- Microstrip Feed
- DXF Layout Import
- 2D and 3D Results

# Step 1: Start

- Start Empire XPU
- Select „**New Project**“ Tab, OK
- File – Save As (create new folder)
- Enter file name, e.g. **array**

- Click “Simulation Setup” 
- Select “**EM Setup**” Tab

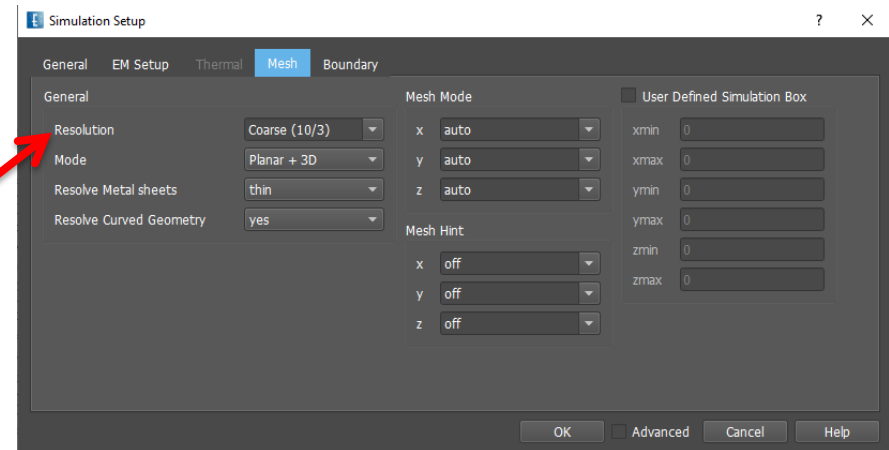


Start Frequency: **20 GHz**

Stop Frequency: **30 GHz**

Target Frequency: **24.5 GHz**

- Select „**Mesh**“ Tab
- Set Resolution: **Coarse (10/3)**
- Confirm OK, Close OK



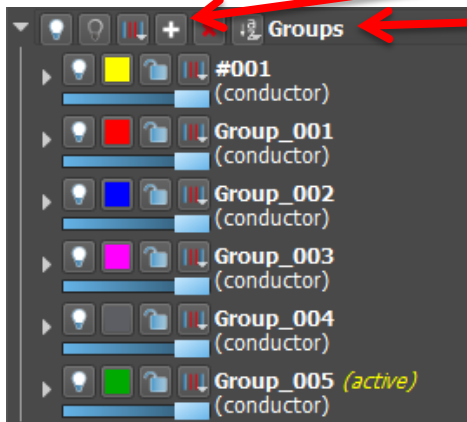
*Comment: Coarse (10/3) means:*

- *Minimum 10 cells per minimum wavelength*
- *Minimum 3 cells for each object's bounding box*

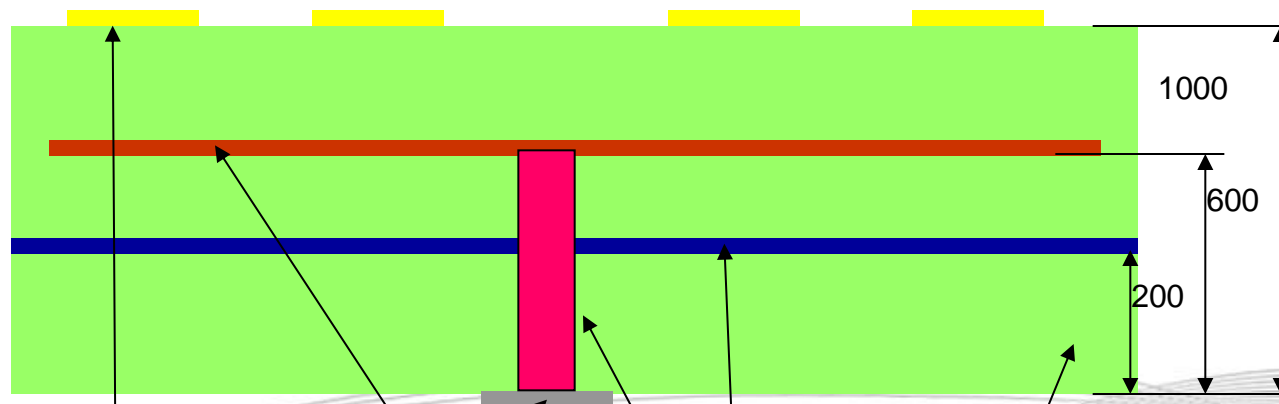
# Step 2: Create Layer Stack

Group Tree Editor

Name	Status	Objects	Dir.	Start	Stop	Physical Property
Top	Modified	0	z	1000	1015	conductor
04	Modified	0	z	600	615	conductor
Ground	Modified	0	z	200	215	conductor
Via	Modified	0	z	0	600	conductor
Microstrip	Modified	0	z	-15	0	conductor
Substrate	Modified	0	z	0	1000	dielectric name Dupont-951 prio 100 epsr 7.8 tand 0.005



- Click "Add Group" 5 times, recolor groups
- Right Click on "Groups", select "Edit Group Tree"
- Double-click and edit Names, Start & Stop Values
- Change "Substrate" property to Dielectric → Database → Dupont-951
- OK



Metallization Thickness: 15  $\mu\text{m}$   
 Metallization conductivity: infinite  
 Substrate Material Dupont 951:  $\epsilon_r = 7.8$   
 All dimensions in  $\mu\text{m}$

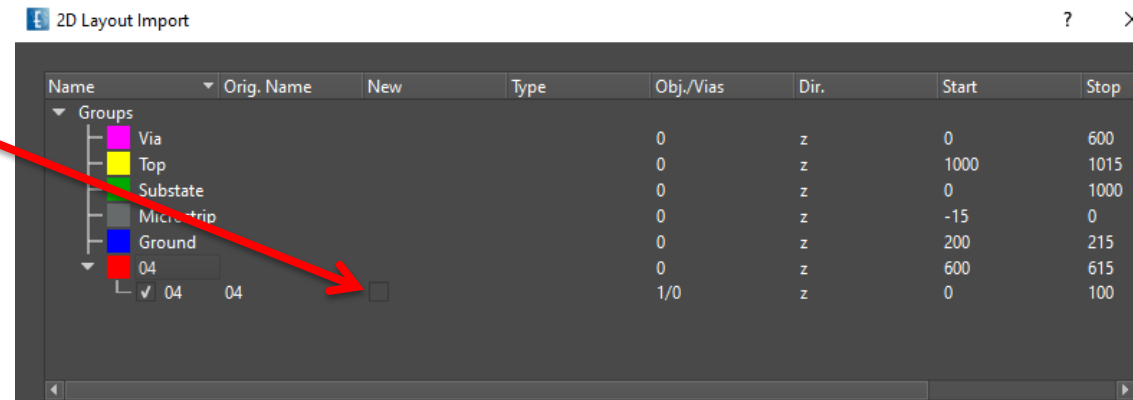
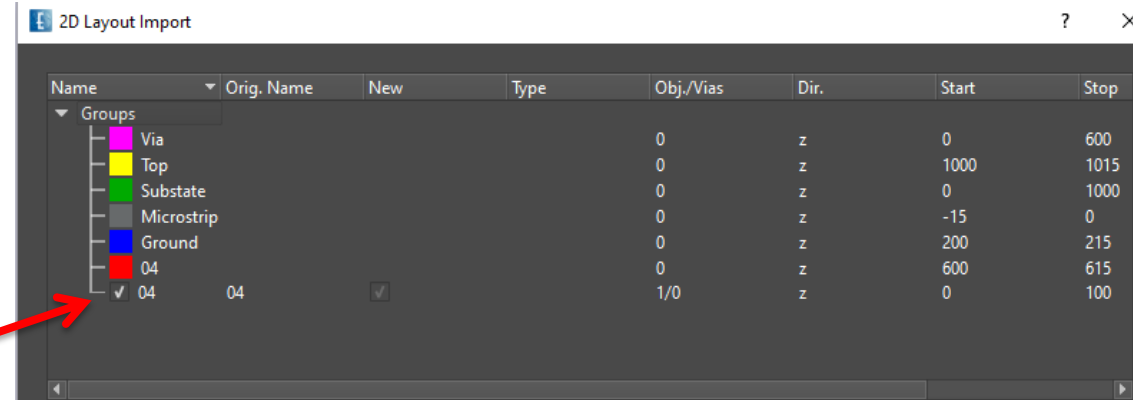
„Top“ (z=1000...1015)  
 „04“ [zero four](z=600...615)  
 „Ground“ (z=200...215)  
 „Via“ (z=0...600)  
 „Substrate“ Dupont 951 (z=0...1000)

# Step 3: Feed Network

*Comment: Top view display is always assumed as default during structure setup*








- Select “2D Design” Tab
- Select File → Import → 2D Layout → Import DXF (2D)
- Locate and select network.dxf \*
- Confirm File dialog
- Drag&Drop new group into group “04”
- Uncheck “New” checkmark
- Click OK

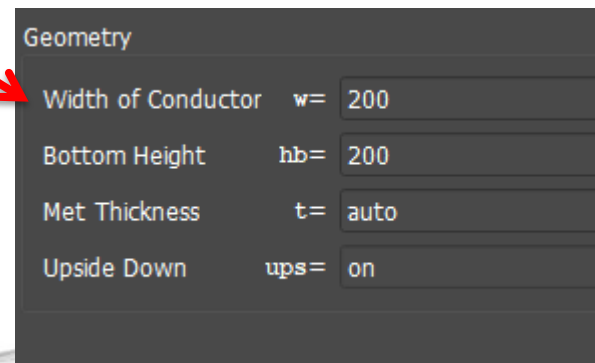
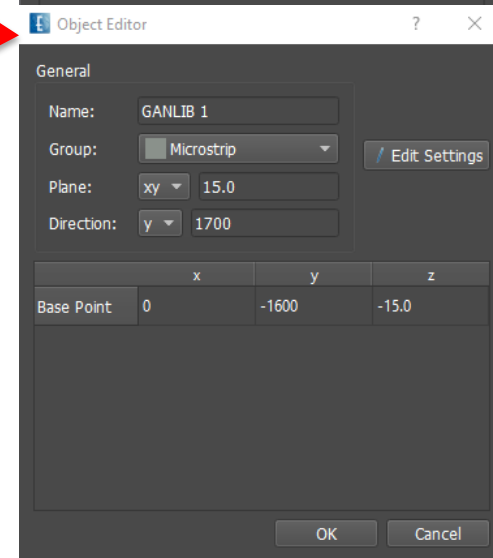
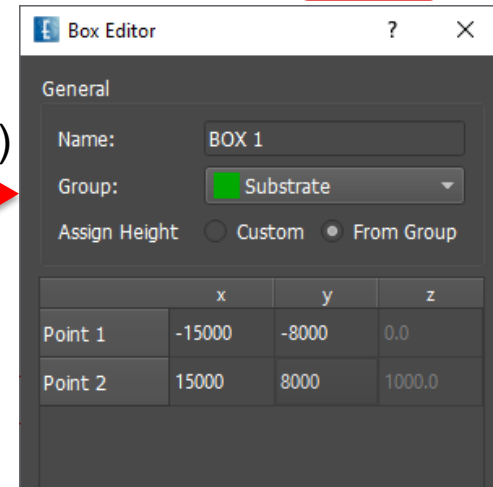


\* e.g.

C:\EMPIRE\_XPU\_8.01\Tutorials\2D Design\08 LTCC Array\data

# Step 4: Substrate and Port



- Verify “active” group “Substrate”, (if not, set active with right click)
- Click Create Box  
- Set Point 1  $x=-15000$ ,  $y=-8000$  Point 2:  $x=15000$ ,  $y=8000$
- OK, Zoom extents 
- Right click on “Microstrip”, Set Active
- Click ‘Create Source’  , Select ‘Planar’ – ‘MSL’ 
- Choose Direction y, 1700 (=port length)
- Base Point:  $x=0$ ,  $y=-1600$
- Click “Edit Settings”, checkmark “Advanced”
- Adjust values :  $w=200$ ,  $hb=200$ , Upside down: on
- Click 2x OK

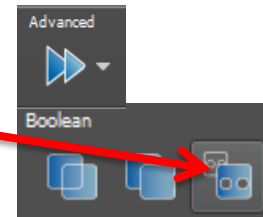
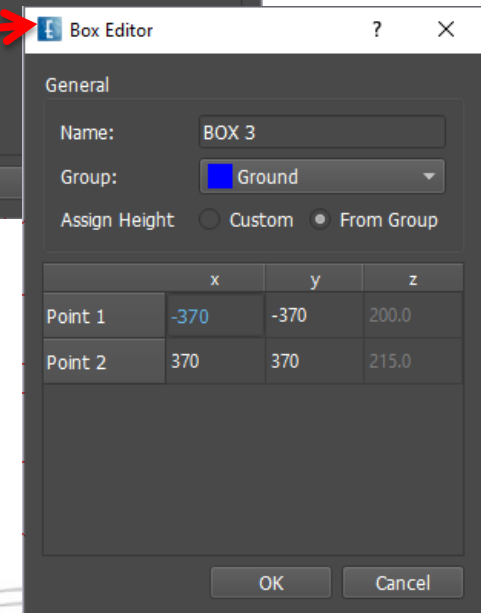
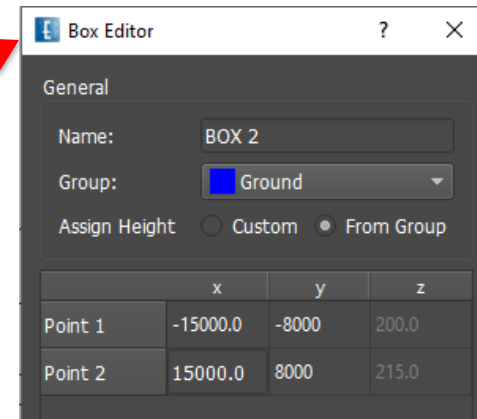


## Comments:

- Z-values of the groups defined in Step 2 will be used.
- Upside down is chosen because ground plane of MSL above the strip
- Length of the MSL is chosen large enough to establish proper mode at port plane



# Step 5: Ground Plane with hole

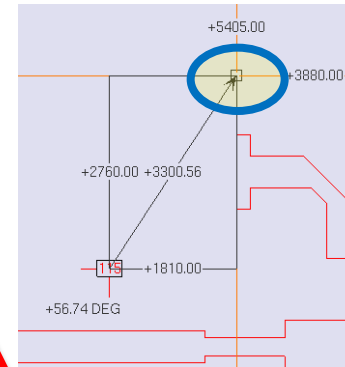
- Right click on “Ground”, Set active
- Click ‘Create Box’ 
- Point 1: x=-15000, y=-8000
- Point 2: x=15000, y=8000, OK
- Click ‘Create Box’ 
- Point 1: x=-370, y=-370
- Point 2: x=370, y=370, OK
- Right click on group “Ground”
- Choose “Select Group’s Objects”
- Click ‘Advanced – Boolean – Multiple Subtract’ to cutout a section for the via



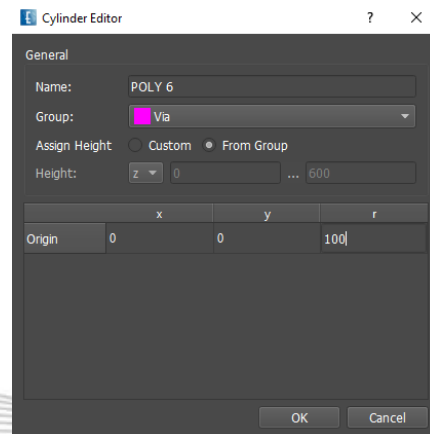
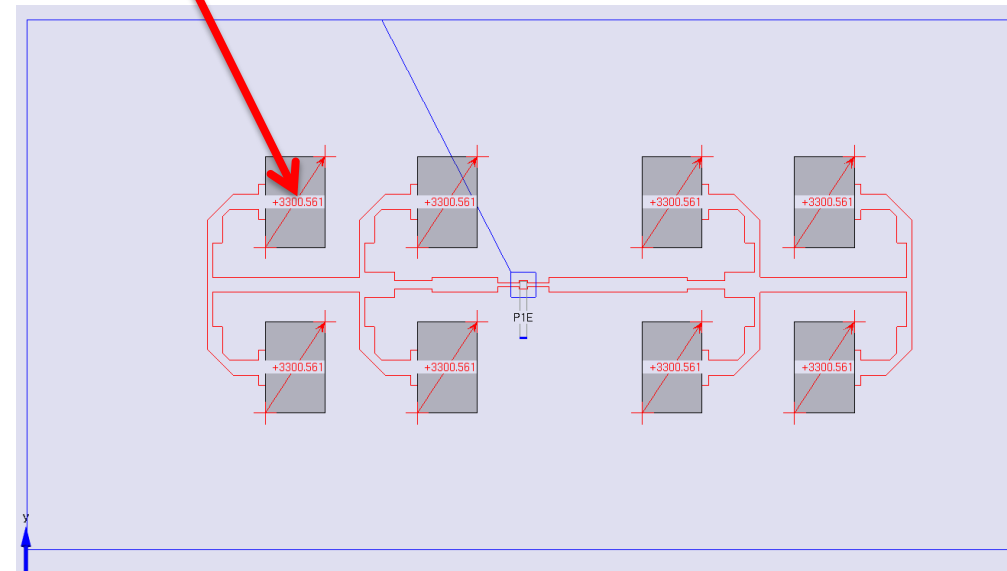
*Comment: A cut-line is drawn to indicate that the result is a single object*

# Step 6: Stacked Patches and Via

- Activate group “Top” (set active)
- Draw arrows across all patches by dragging left mouse button (Hint: Use patch corners as reference)
- Click  to draw the Patches, OK
- Set group “Via” as active
- Click  ‘Create Cylinder’
- Set  $x=0$ ,  $y=0$ , Radius  $r=100$
- OK



The square at the cursor indicates a snap to the corner of the object

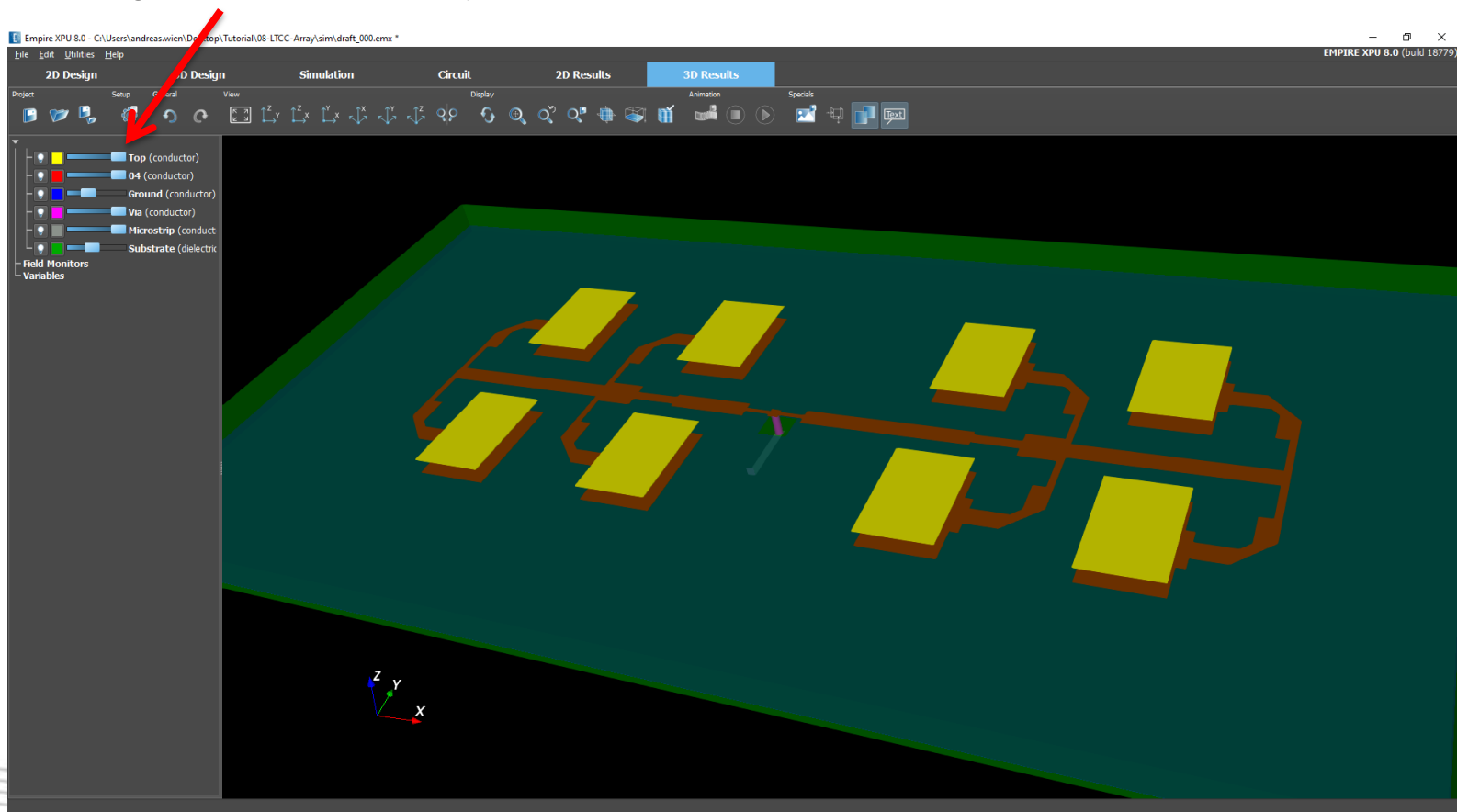


Comment: Here, the object snap helps to draw the arrows to create boxes with the same cross section as the patches of the feeding network.





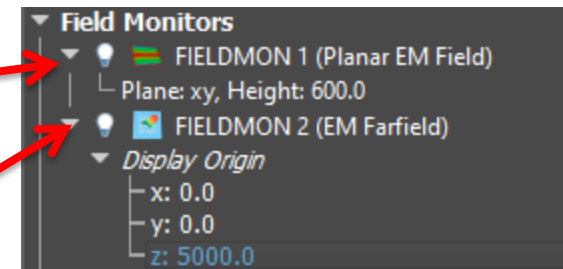
# Step 7: Check Input

- Select “3D Results”
- Adjust groups transparency sliders as shown



# Step 8: Field Recording

- Select “2D Design” Tab
- Click “Create Field Monitor” 
- Select - EM Field – ‘Plane’, OK
- Expand “Field Monitor” “FIELDMON 1”
- Double click “Plane” - Enter xy=600
- Click “Create Field Monitor” 
- Select - EM Far Field monitor – Boundary, OK
- Expand “FIELDMON 2”
- Set Display Origin x=0, y=0, z=5000\*

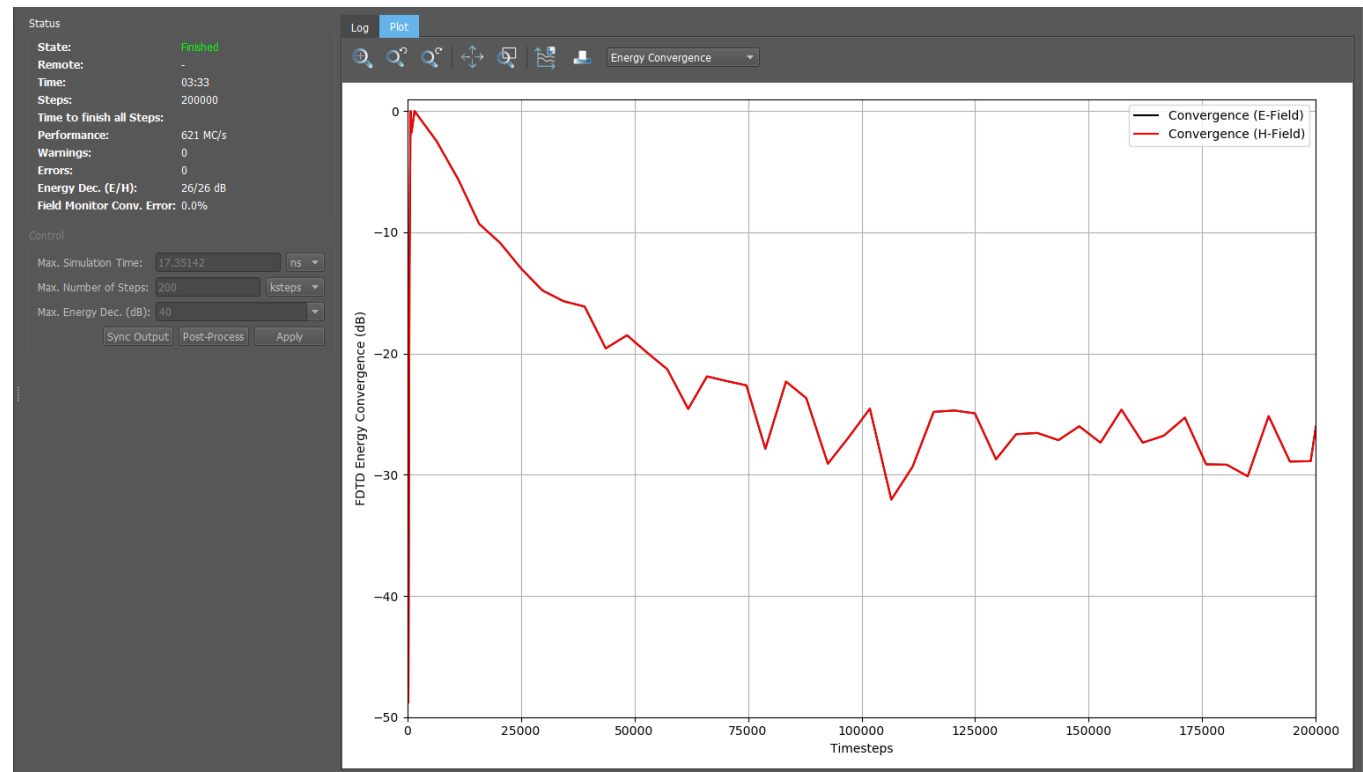


\*Point specifies far field center for display

# Step 9: Simulation

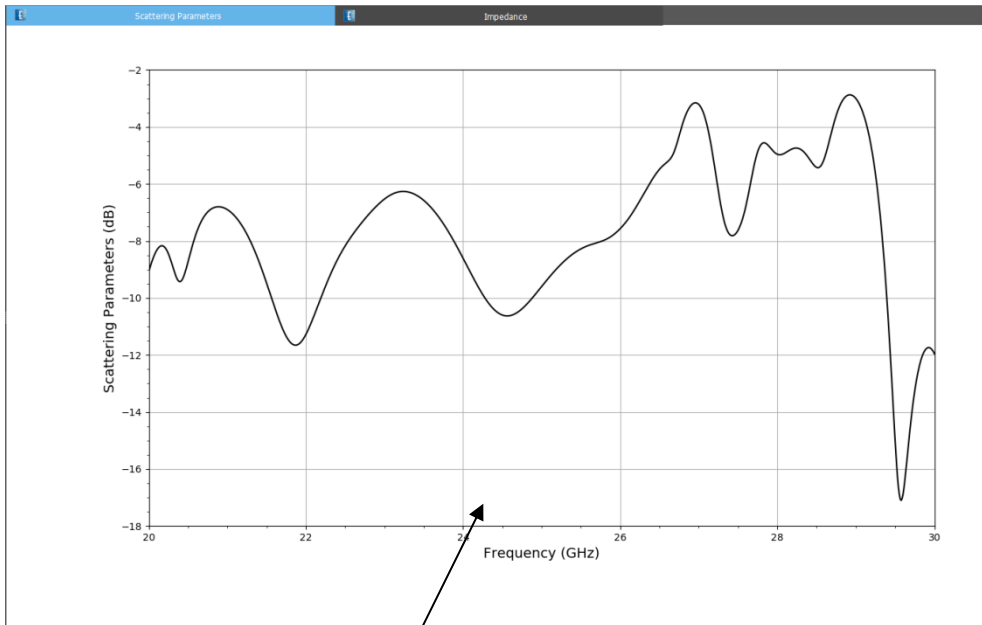
- Click “Start Simulation”, OK
- Wait to finish Simulation
- Check the results

Energy vs. timesteps



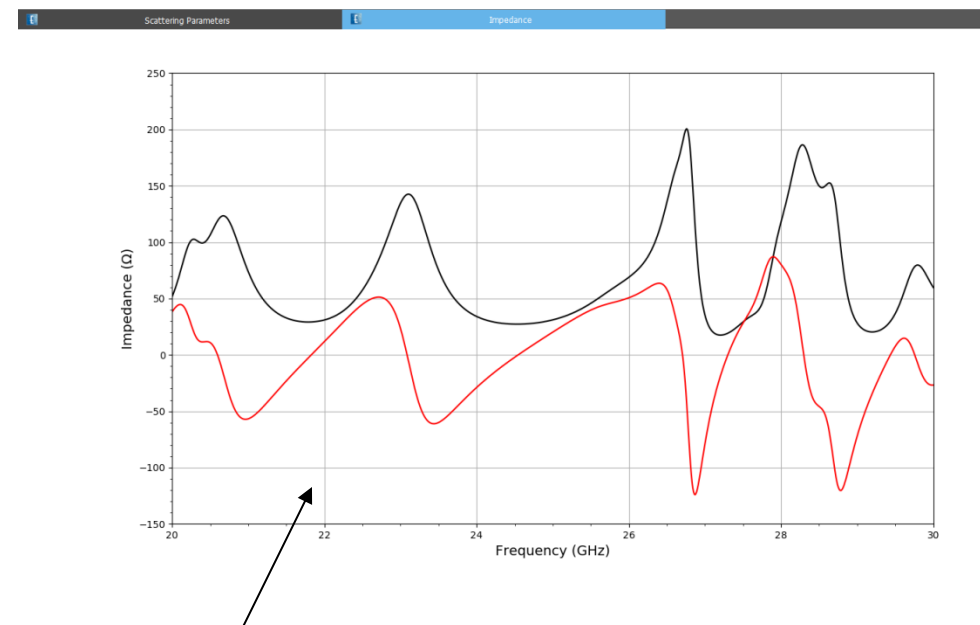
# Step 10: Results

## S-Parameter



S-Parameter plot is there per default

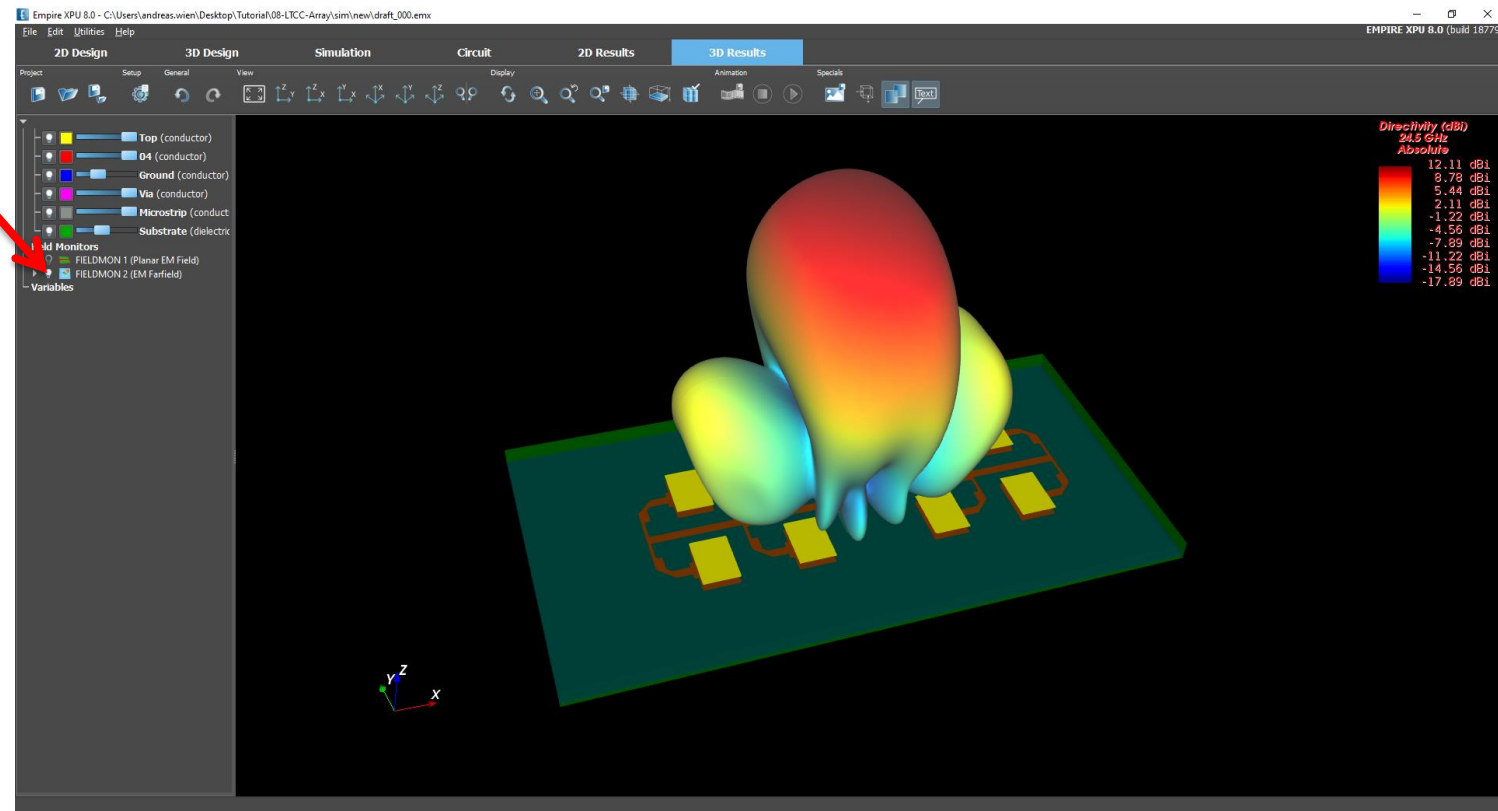
## Impedance Z1.in



Click "Add Result" to add impedance plot

# Step 11: Far Field Animation

- Return to 2D Design mode
- Switch On Monitor “EM Farfield”
- Switch to the 3D Results mode



# Step 12: Near Field

## → Near Field Animation Definition

- Right Click on Planar EM Field – Edit
- Field Components: z
- Animation Loop Type : phase\_loop\_15\_deg
- Field Plot Amplitude: 2500, OK

## → 3D Near Field Result

- Switch off visibility of “EM Farfield”, “Substrate” and “Top”
- Switch on visibility of “Planar EM Field”
- Start Animation in 3D Results tab

